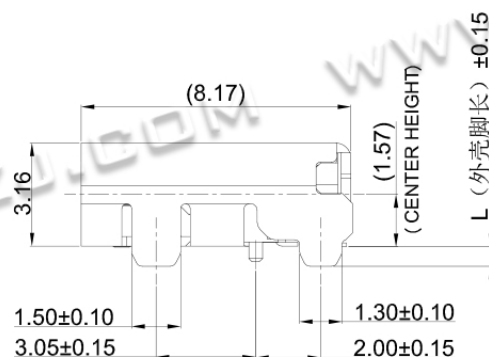
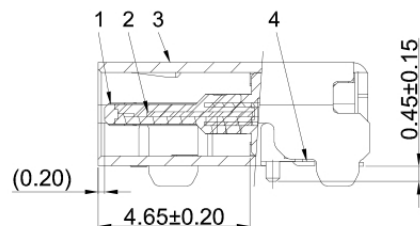
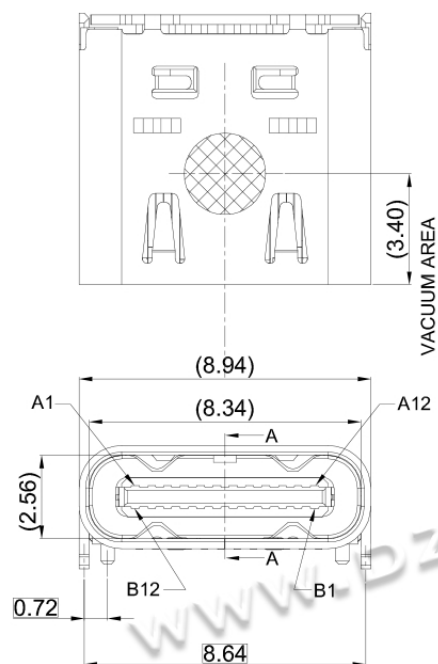
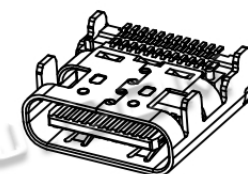




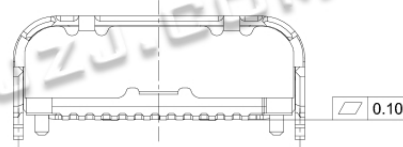
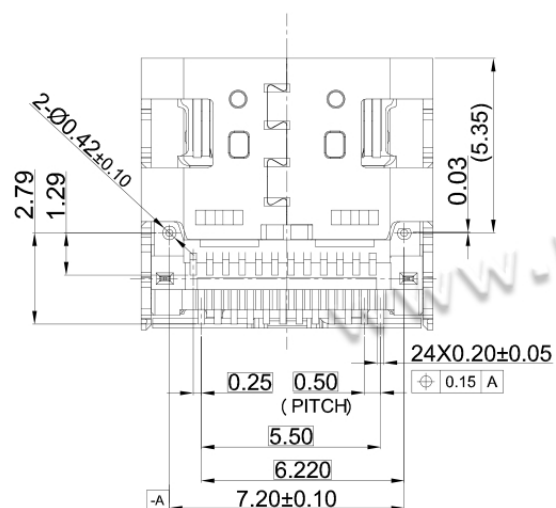
无DIP脚



NOTE/注释:

1. SPECIFICATION/规格:

- 1.1 Rated current (额定电流): 5.0 A
- 1.2 Voltage rating (额定电压): 5V AC
- 1.3 Contact Resistance (接触阻抗): 40 m Ω Max.
- 1.4 Insulation Resistance (绝缘阻抗): 100MΩ Min.
- 1.5 Withstanding voltage (耐电压): 100 VAC/minute
- 1.6 Mating force (插入力): 5~20N.
- 1.7 Unmating force (拔出力): 8~20N.
- 1.8 Durability Cycle(寿命循环): 10,000 cycle
- 1.9 Operating temperature (工作温度): -40°~+85°



1.60
1.20
0.90
0.60
外壳脚长L

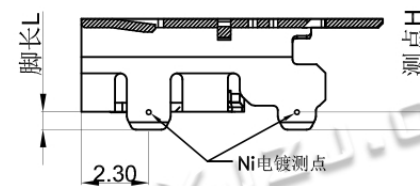
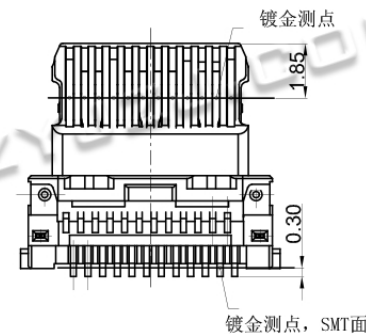
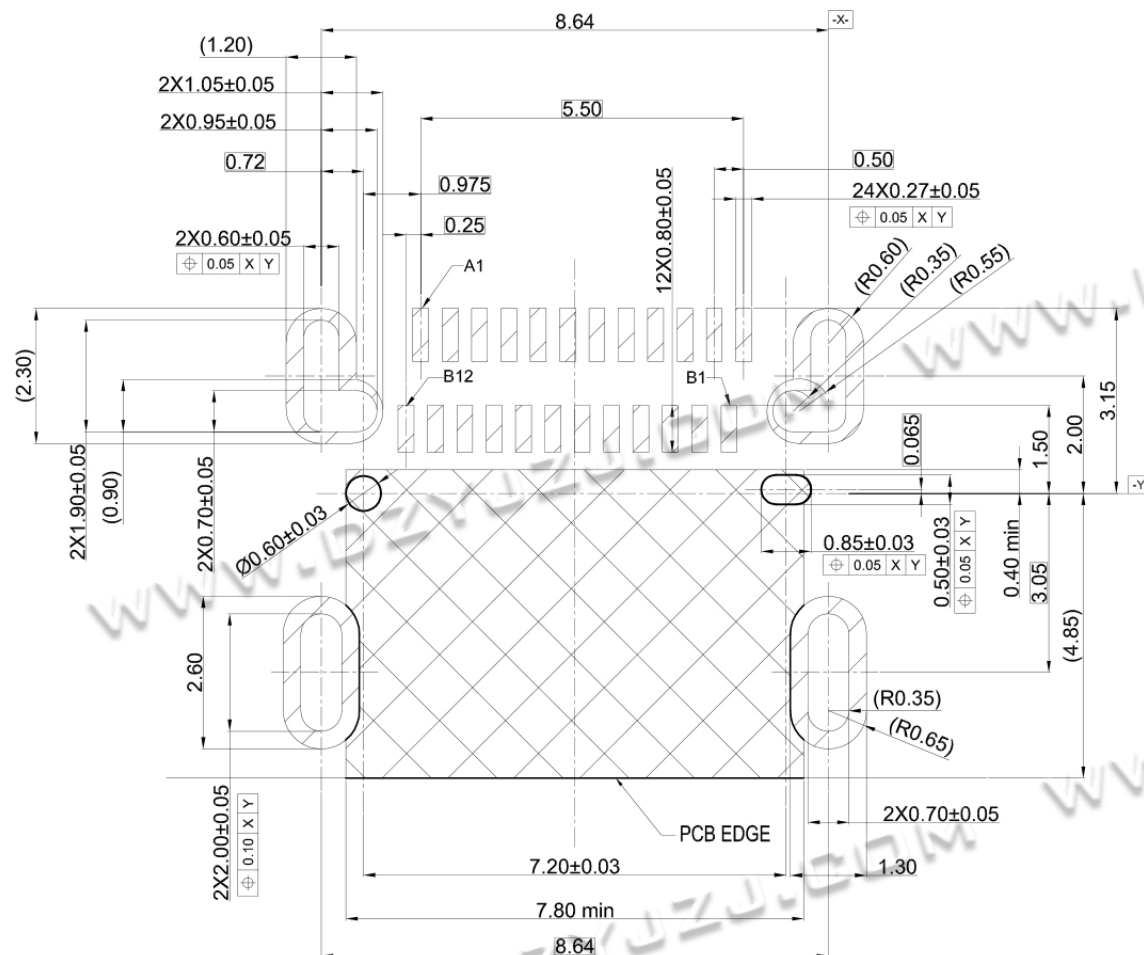
PIN ASSIGNMENT:

A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12
GND	TX1+	TX1-	Vbus	CC1	D+	D-	SBU1	Vbus	RX2-	RX2+	GND
B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1
GND	RX1+	RX1-	Vbus	SBU2	D-	D+	CC2	Vbus	TX2-	TX2+	GND



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: USB TYPE C 4.0母座24P 双贴SMT 板上平贴CH=1.57 L=8.17
CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. MOLD NO.	HYC469-USBC24-XXX
APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: SHEET NO.	HYC-2310120847 1 OF 1

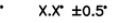


1.60	1.50
1.20	1.10
0.90	0.90
0.60	0.60
壳脚长L	镍测点H

4	TERMINAL	24	COPPER ALLOY	MATING SIDE:SEE PART NO; SOLDER TAIL:Gold FLASH, 50u" NICKEL OVERALL.	T=0.12
3	SHELL	1	SUS304	30U" NICKEL PLATING	T=0.30
2	MID PLATE	1	SUS301-H	RINSE	T=0.15
1	MAIN HOUSING	1	HIGH TEMPERATURE	PA9T BLACK	UL94V-0
ITEM	DESCRIPTION	Q'TY	MATERIAL	FINISH	REMARK
BILL OF MATERIAL					



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*		DRAWN BY : 陈一鸣		DATE : 2014-02-23		PART NAME: USB TYPE C 4.0母座24P 双贴SMT 板上平贴CH=1.57 L=8.17	
 UNIT: mm [inch]		CHECKED BY: 马跃		DATE : 2014-02-23		PART NO.	HYC469-USBC24-XXX
		APPROVED BY: 邱敏		DATE : 2014-02-23		MOLD NO.	
SCALE:1:1 SIZE: A4				DRAW NO:		HYC-2310120847	
				SHEET NO.		1 OF 1	